ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES	C, Bannockb	urn, Illinois. A	Il rights reserved untions.	nder both	This docum level parts, t	ent is a declarati the declaration e	on of the subs ncompasses a	stances withi 11 lower leve	n the manufacture l materials for wh	er listed it hich the m	em. Note: if anufacturer	f the item is an as has engineering	sembly with lower responsibility.
	.1 IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis								als and Mfg Information				
Supplier Information													
Company name*	Company unique ID			Unique ID Authority				Response Date*					
onsemi										2025-05-11			
Contact Name Title - Con			tle - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title			Fitle - Representative			Phone - Representative*				Email - Representative*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number Mfr Item Name				Effective Date	Version	Manuf	Manufacturing Site		Weight*	UOM	Unit Type
	MMSD4	148T1G	SS SOD123 SWCH DIO 100V			2025-05-11		CN1	CN1		1.525	mg	Each
Manufacturing Proccess Informati	on		·					-					·
Terminal Plating / Grid Array Mate	Terminal Plating / Grid Array Material Terminal Base		Alloy	J-STD-020 MSL	Rating	Peak Proc	ess Body Tem	perature M	ax Time at Peak	Temperat	ure Numb	er of Reflow Cyd	eles
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260	C	C 30	•	secon	ds 3		
Comments													
level 1 - maximum time at peak temperatur	e during sol	dering is 10-3	0 seconds										
for more information regarding material c	omposition	please refer to	o page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl nthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.88	mg	Supplier	Silicon (Si)	7440-21-3		0.88	mg
Lead Frame	3.19	mg	В	Nickel (Ni)	7440-02-0		1.158	mg
			Supplier	Iron (Fe)	7439-89-6		1.6014	mg
			Supplier	Copper (Cu)	7440-50-8		0.4306	mg
Mold Compound-Black	6.51	mg	Supplier	Boron zinc hydroxide oxide	138265-88-0		0.1953	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0325	mg
			Supplier	2,4,6-triamino-s-triazincompd.withs- triazine-triol	37640-57-6		0.1953	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		5.208	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0651	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.5208	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.2929	mg
Plating	0.8	mg	Supplier	Tin (Sn)	7440-31-5		0.8	mg
Wire Bond	0.145	mg	Supplier	Palladium (Pd)	7440-05-3		0.0019	mg
			Supplier	Copper (Cu)	7440-50-8		0.1431	mg